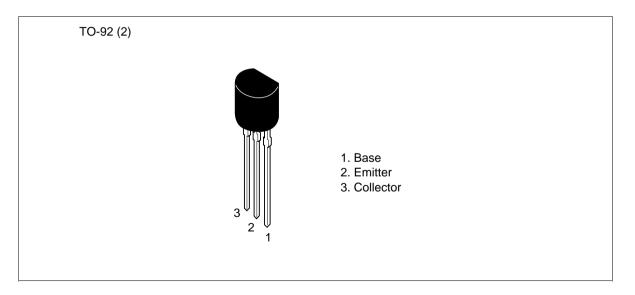
Silicon NPN Epitaxial

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#### Application

- UHF Amplifier
- UHF TV Tuner, Local oscillator

#### Outline



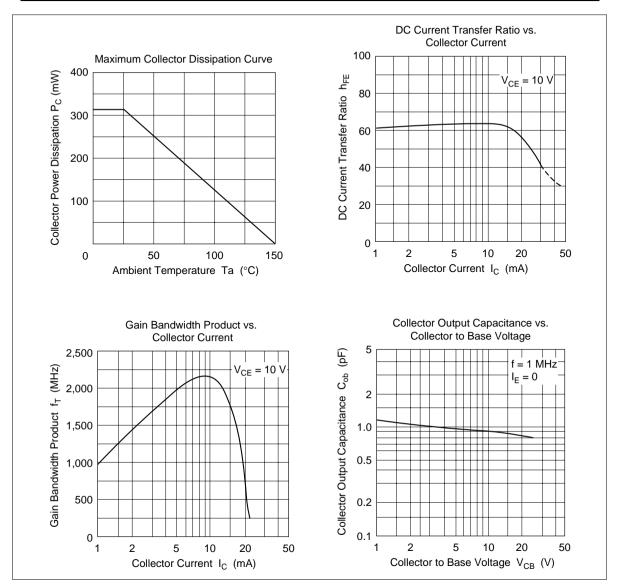


## **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

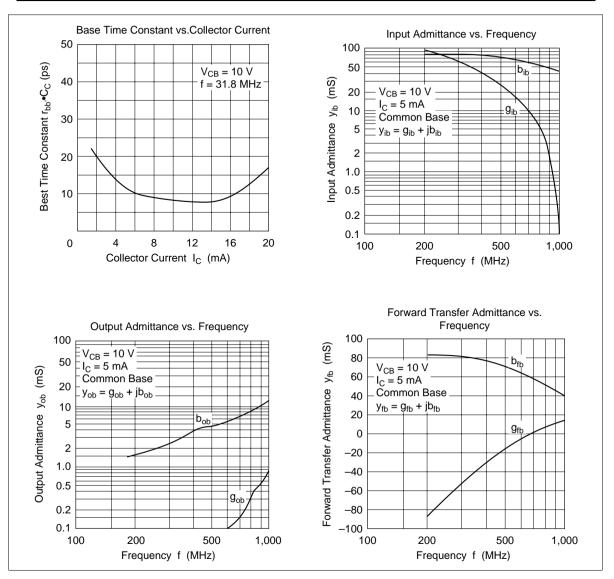
Item	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	30	V
Collector to emitter voltage	V <sub>CEO</sub>	30	V
Emitter to base voltage	V <sub>EBO</sub>	3	V
Collector current	Ι <sub>c</sub>	50	mA
Collector power dissipation	Pc	310	mW
Junction temperature	Тј	150	°C
Storage temperature	Tstg	-55 to +150	٥C

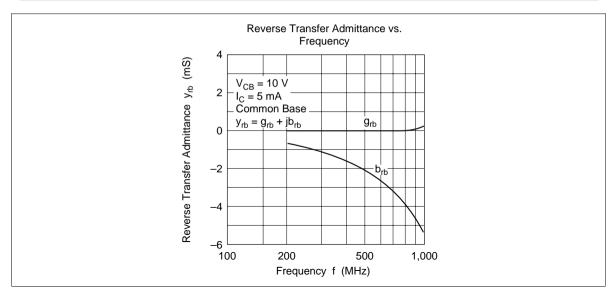
## **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	30	_	_	V	$I_c = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	3	—	—	V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	100	nA	$V_{CB} = 24 \text{ V}, I_{E} = 0$
Emitter cutoff current	I <sub>EBO</sub>	—	—	100	nA	$V_{EB} = 2 V, I_{C} = 0$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	—	300	mV	$I_{c} = 10 \text{ mA}, I_{B} = 5 \text{ mA}$
Base to emitter voltage	V <sub>BE</sub>	—	—	0.95	V	$V_{ce} = 10 \text{ V}, I_c = 5 \text{ mA}$
DC current transfer ratio	$\mathbf{h}_{\text{FE}}$	20	—	—		$V_{ce} = 10 \text{ V}, I_c = 5 \text{ mA}$
Gain bandwidth product	f <sub>T</sub>	1000	2000		MHz	$V_{ce} = 10 \text{ V}, I_c = 5 \text{ mA}$
Collector output capacitance	Cob	—	0.9	1.5	pF	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0, \text{ f} = 1 \text{ MHz}$
Base time constant	$r_{bb'} \cdot C_C$	—	12	20	ps	$V_{cB} = 10 \text{ V}, I_c = 5 \text{ mA}, f = 31.8 \text{ MHz}$

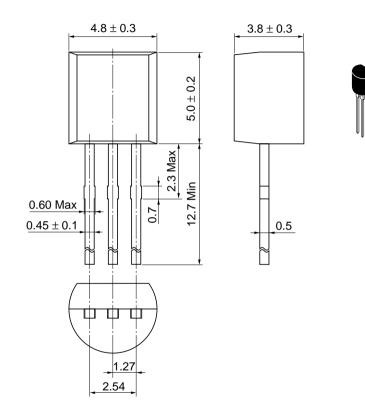


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Hitachi Code	TO-92 (2)
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.25 g

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